





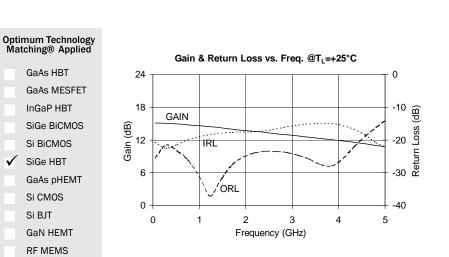




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The SGA2263Z is a high performance SiGe HBT MMIC Amplifier. A Darlington configuration featuring one-micron emitters provides high F_T and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. Only two DC-blocking capacitors, a bias resistor, and an optional RF choke are required for operation.



Features

- High Gain: 13.8dB at 1950 MHz
- Cascadable 50Ω
- Operates from Single Supply
- Low Thermal Resistance Package

Applications

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier

nd

Wireless Data, Satellite

Parameter	Specification			Unit	Condition	
Farameter	Min.	Тур.	Max.	Unit	Condition	
Small Signal Gain	13.2	14.7	16.2	dB	850MHz	
		13.5		dB	1950MHz	
		13.2		dB	2400MHz	
Output Power at 1dB Compression		7.5		dBm	850MHz	
		6.1		dBm	1950MHz	
Output Third Intercept Point		20.2		dBm	850MHz	
		18.0		dBm	1950MHz	
Bandwidth Determined by Return Loss		5000		MHz	>10dB	
Input Return Loss		17.6		dB	1950MHz	
Output Return Loss		25.3		dB	1950MHz	
Noise Figure		3.5		dB	1950MHz	
Device Operating Voltage	1.9	2.2	2.5	V		
Device Operating Current	17	20	23	mA		
Thermal Resistance		255		°C/W	junction - lead	

Test Conditions: $V_S = 5V$, $I_D = 20$ mA Typ., OIP₃ Tone Spacing=1MHz, P_{OUT} per tone=-10dBm, $R_{BIAS} = 140\Omega$, $T_L = 25$ °C, $Z_S = Z_L = 50\Omega$

SGA2263Z



Absolute Maximum Ratings

•		
Parameter	Rating	Unit
Max Device Current (I _D)	40	mA
Max Device Voltage (V _D)	4	V
Max RF Input Power	+18	dBm
Max Junction Temp (T_J)	+150	°C
Operating Temp Range (T_L)	-40 to +85	°C
Max Storage Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent dam-age. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression:

 $I_D V_D < (T_J - T_L) / R_{TH}$, j-l

Typical Performance at Key Operating Frequencies



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions no reaction of the device may reduce device reliability. Specified typical perfor-mance or functional operation of the device under Absolute Maximum Rating condi-tions is not implied.

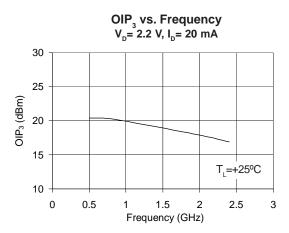
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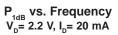


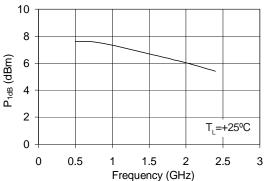
RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000 ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

Parameter	Unit	100 MHz	500 MHz	850 MHz	1950MHz	2400 MHz	3500MHz
Small Signal Gain	dB		14.9	14.7	13.5	13.2	
Output Third Order Intercept Point	dBm		20.4	20.2	18.0	16.9	
Output Power at 1dB Compression	dBm		7.6	7.5	6.1	5.4	
Input Return Loss	dB	21.3	21.5	19.6	17.6	17.2	15.0
Output Return Loss	dB	24.1	23.0	27.8	25.3	23.4	26.7
Reverse Isolation	dB	17.8	18.5	18.7	19.1	19.2	19.2
Noise Figure	dB		3.3	3.2	3.5	4.0	

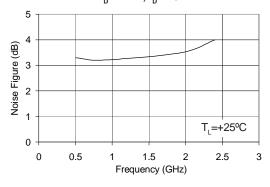
Test Conditions: V_S=5V, I_D=20mA Typ., OIP₃ Tone Spacing=1MHz, P_{OUT} per tone=-10dBm, R_{BIAS}=140 Ω , T_L=25°C, Z_S=Z_L=50 Ω







Noise Figure vs. Frequency $V_{p} = 2.2 \text{ V}, I_{p} = 20 \text{ mA}$

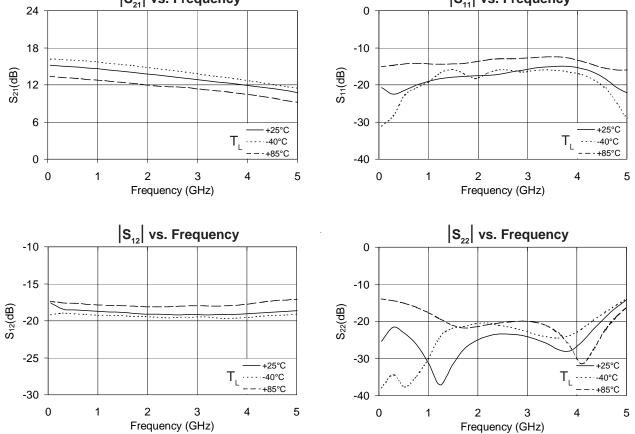


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Typical RF Performance Over Temperature (Bias: $V_D = 2.2 V$, $I_D = 20 \text{ mA (Typ.)}$) $|S_{21}|$ vs. Frequency $|S_{11}|$ vs. Frequency



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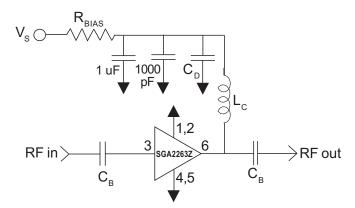
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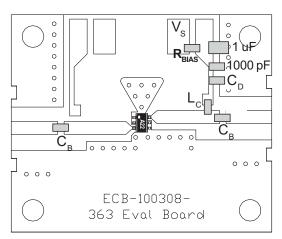
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Pin	Function	Description
3	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
1, 2,	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.
4, 5		bie.
6	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper oper- ation





Application Circuit

Reference	Frequency (Mhz)						
Designator	500	850	1950	2400	3500		
C _B	220 pF	100 pF	68 pF	56 pF	39 pF		
C _D	100 pF	68 pF	22 pF	22 pF	15 pF		
L _c	68 nH	33 nH	22 nH	18 nH	15 nH		

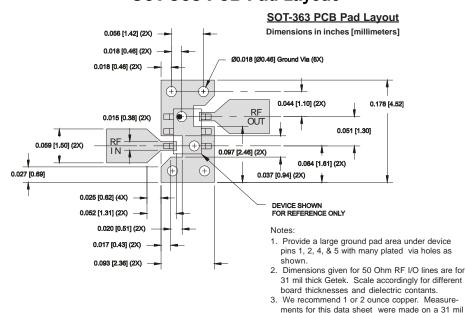
Recommended Bias Resistor Values for $I_D=20mA$ $R_{BIAS}=(V_S-V_D) / I_D$				
Supply Voltage(V $_{\rm S}$)	5 V	6 V	8 V	10 V
R _{BIAS}	140 <i>Ω</i>	200 N	300 Ω	390 N
Note: R _{BIAS} provides DC bias stability over temperature.				

Mounting Instructions

- Use a large ground pad area near device pins 1, 2,
 4, and 5 with many plated through-holes as shown.
- 3. We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

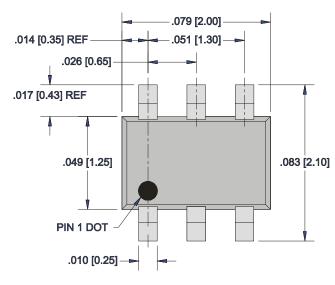


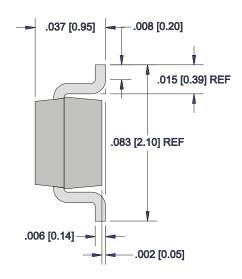




SOT-363 PCB Pad Layout

SOT-363 Nominal Package Dimensions

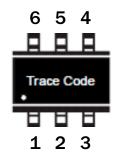




thick Getek with 1 ounce copper on both sides.



Part Identification Marking



Ordering Information

Ordering Code	Description
SGA2263Z	7" Reel with 3000 pieces
SGA2263ZSQ	Sample bag with 25 pieces
SGA2263ZSR	7" Reel with 100 pieces
SGA2263ZPCK1	850MHz, 5V Operation PCBA with 5-piece sample bag

